

## **Supporting Information**

### **Benzimidazole-based mononuclear polypyridyl Cu(II) complexes towards DNA binding, cleavage, and *in vitro* antiproliferative studies**

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**Table S1** Selected crystallographic data for **1**, **2** and **3**

<b>Complex</b>	<b>1</b>	<b>2</b>	<b>3</b>
Empirical formula	C <sub>65</sub> H <sub>61</sub> Cl <sub>4</sub> Cu <sub>2</sub> N <sub>15</sub> O <sub>19</sub>	C <sub>35</sub> H <sub>28</sub> Cl <sub>2</sub> CuN <sub>8</sub> O <sub>8</sub>	C <sub>35</sub> H <sub>29</sub> Cl <sub>2</sub> CuN <sub>7</sub> O <sub>8</sub>
Formula weight	1611.14	823.09	810.09
Temperature/K	298.00	298.00	298.00
Crystal system	triclinic	triclinic	monoclinic
Space group	<i>P</i> -1	<i>P</i> -1	<i>P</i> 2 <sub>1</sub> / <i>c</i>
<i>a</i> /Å	8.9566(9)	9.1527(7)	13.4155(9)
<i>b</i> /Å	13.6649(12)	14.2703(11)	15.0657(10)
<i>c</i> /Å	29.392(3)	14.6239(11)	18.0834(10)
<i>α</i> /°	80.736(3)	90.791(3)	90
<i>β</i> /°	84.755(3)	99.831(3)	102.119(2)
<i>γ</i> /°	82.120(3)	108.495(2)	90
Volume/Å <sup>3</sup>	3508.0(6)	1780.1(2)	3573.5(4)
<i>Z</i>	2	2	4
ρ <sub>calc</sub> /cm <sup>3</sup>	1.525	1.536	1.506
μ/mm <sup>-1</sup>	0.841	0.828	0.823
F(000)	1652.0	842.0	1660.0
Crystal size/mm <sup>3</sup>	0.06 × 0.06 × 0.04	0.08 × 0.08 × 0.06	0.06 × 0.06 × 0.04
Radiation	MoKα (λ = 0.71073)	MoKα (λ = 0.71073)	MoKα (λ = 0.71073)
2θ range for data collection/°	3.54 to 54.206	3.986 to 54.206	3.552 to 54.43
Index ranges	-11 ≤ <i>h</i> ≤ 11, -16 ≤ <i>k</i> ≤ 17, -37 ≤ <i>l</i> ≤ 37	-11 ≤ <i>h</i> ≤ 11, -18 ≤ <i>k</i> ≤ 18, -18 ≤ <i>l</i> ≤ 18	-17 ≤ <i>h</i> ≤ 17, -19 ≤ <i>k</i> ≤ 22, -23 ≤ <i>l</i> ≤ 22
Reflections collected	110906	47026	57556
Independent reflections	15497 [R <sub>int</sub> = 0.1390, R <sub>sigma</sub> = 0.0947]	7817 [R <sub>int</sub> = 0.0607, R <sub>sigma</sub> = 0.0442]	7922 [R <sub>int</sub> = 0.0883, R <sub>sigma</sub> = 0.0588]
Data/restraints/parameters	15497/0/887	7817/0/462	7922/0/482
Goodness-of-fit on <i>F</i> <sup>2</sup>	1.032	1.032	1.041
Final R indexes [ <i>I</i> ≥ 2σ ( <i>I</i> )]	R <sub>1</sub> = 0.0643, wR <sub>2</sub> = 0.1565	R <sub>1</sub> = 0.0631, wR <sub>2</sub> = 0.1782	R <sub>1</sub> = 0.0733, wR <sub>2</sub> = 0.2067
Final R indexes [all data]	R <sub>1</sub> = 0.1304, wR <sub>2</sub> = 0.1845	R <sub>1</sub> = 0.0827, wR <sub>2</sub> = 0.1962	R <sub>1</sub> = 0.1260, wR <sub>2</sub> = 0.2440

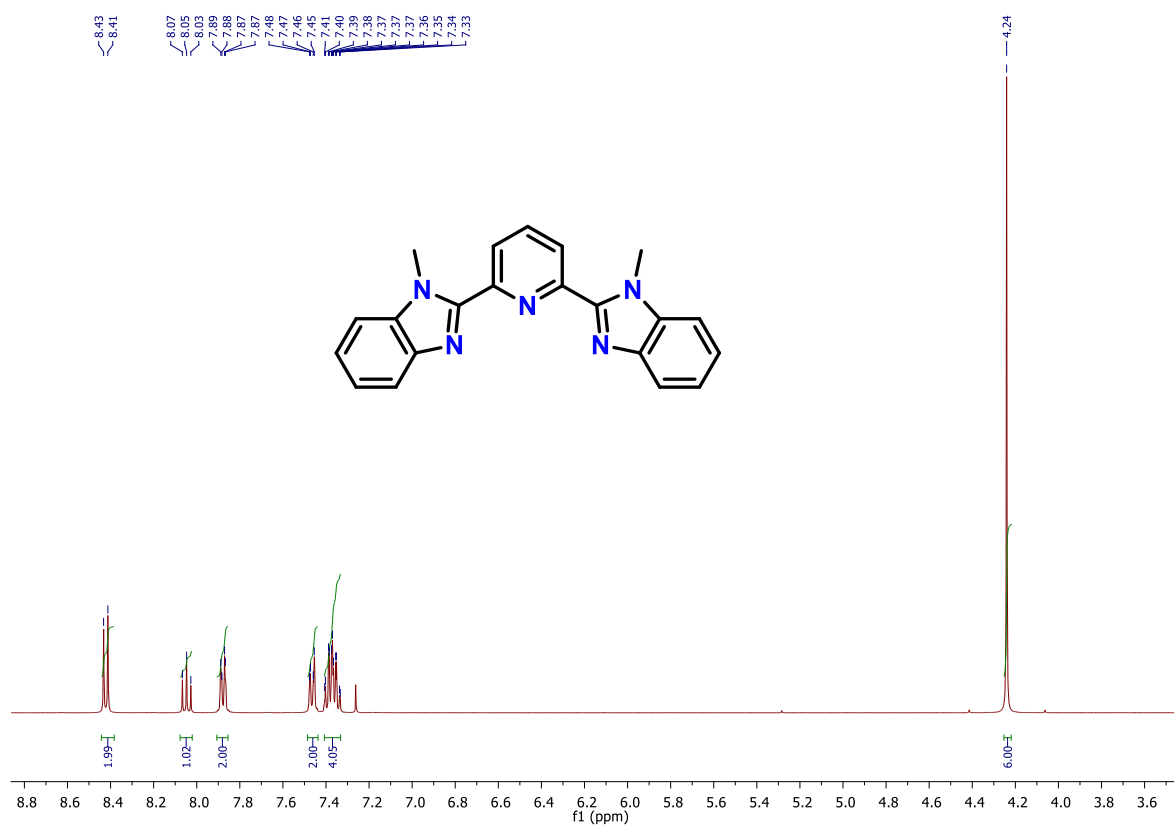
Largest diff. peak/hole / e  
 $\text{\AA}^{-3}$                       0.71/−0.50                      1.57/−1.32                      2.09/−0.73

**Table S2** Selected bond lengths ( $\text{\AA}$ ) and bond angles ( $^\circ$ ) for **1**, **2** and **3**

<b>Complex</b>	<b>1</b>	<b>2</b>	<b>3</b>
Cu1–N1	1.964(3)	1.958(3)	1.964(4)
Cu1–N2	1.998(3)	2.006(3)	2.029(4)
Cu1–N3	2.014(3)	2.023(3)	2.020(4)
Cu1–N4	1.995(3)	1.991(3)	1.993(4)
Cu1–N5	2.192(3)	2.217(3)	2.202(4)
Cu2–N8	1.979(3)	-	-
Cu2–N9	2.031(3)	-	-
Cu2–N10	2.013(3)	-	-
Cu2–N11	2.210(4)	-	-
Cu2–N12	2.007(3)	-	-
N1–Cu1–N2	79.77(14)	80.07(12)	79.26(17)
N1–Cu1–N3	79.80(14)	79.57(12)	80.08(17)
N1–Cu1–N4	170.91(14)	174.03(11)	166.68(18)
N1–Cu1–N5	110.76(14)	106.82(12)	112.67(18)
N2–Cu1–N4	99.44(14)	99.06(12)	100.08(17)
N3–Cu1–N2	157.74(14)	157.68(12)	157.94(18)
N3–Cu1–N4	99.34(14)	100.24(12)	98.24(17)
N5–Cu1–N2	96.48(13)	99.67(12)	99.65(17)
N5–Cu1–N3	98.93(14)	94.88(12)	95.35(17)
N5–Cu1–N4	78.33(13)	79.15(11)	80.61(19)
N8–Cu2–N9	79.31(14)	-	-
N8–Cu2–N10	79.12(13)	-	-
N8–Cu2–N11	99.81(15)	-	-
N8–Cu2–N12	176.88(14)	-	-
N9–Cu2–N11	96.93(14)	-	-
N10–Cu2–N9	156.56(14)	-	-

N10–Cu2–N11	95.67(14)	-	-
N12–Cu2–N9	98.64(13)	-	-
N12–Cu2–N10	103.27(13)	-	-
N12–Cu2–N11	78.04(14)	-	-

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**Fig. S1** <sup>1</sup>H NMR of ligand (L) in CDCl<sub>3</sub> at room temperature.

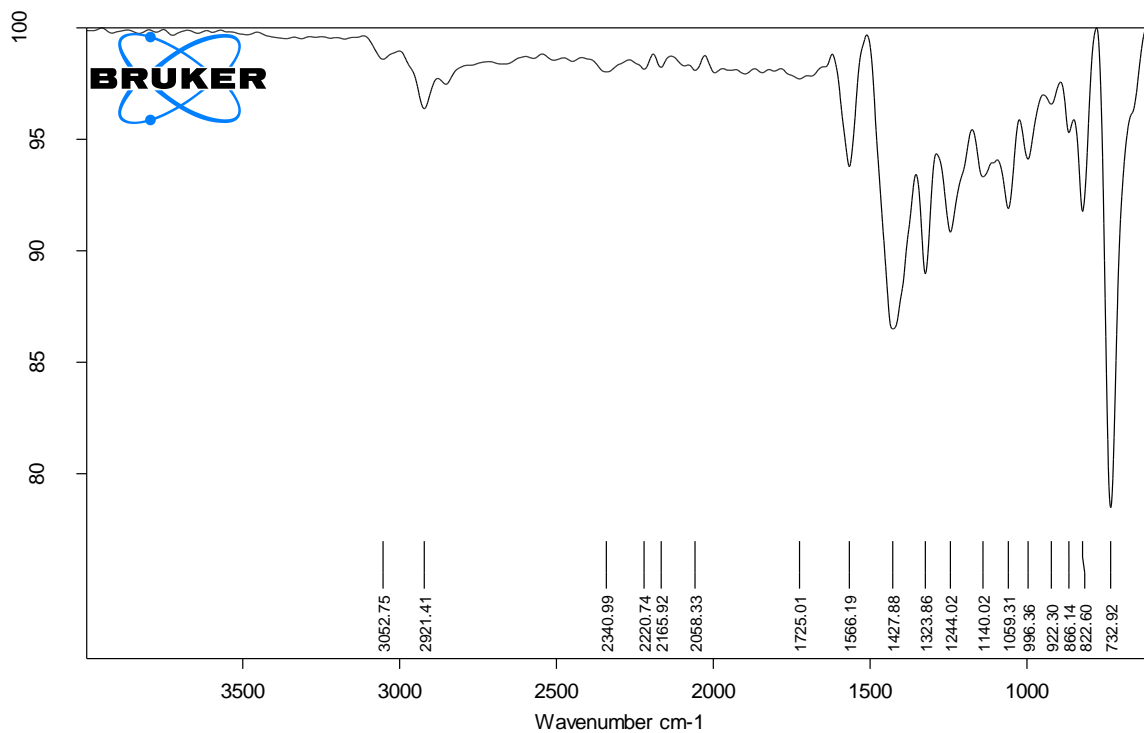
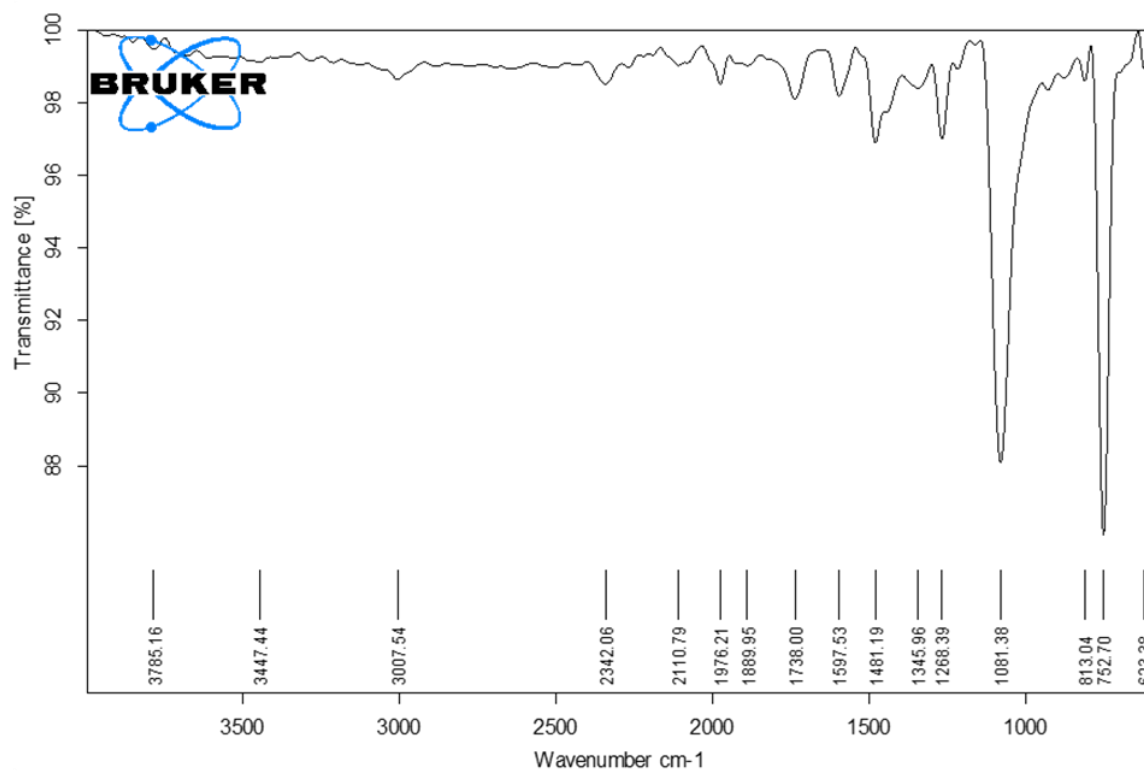
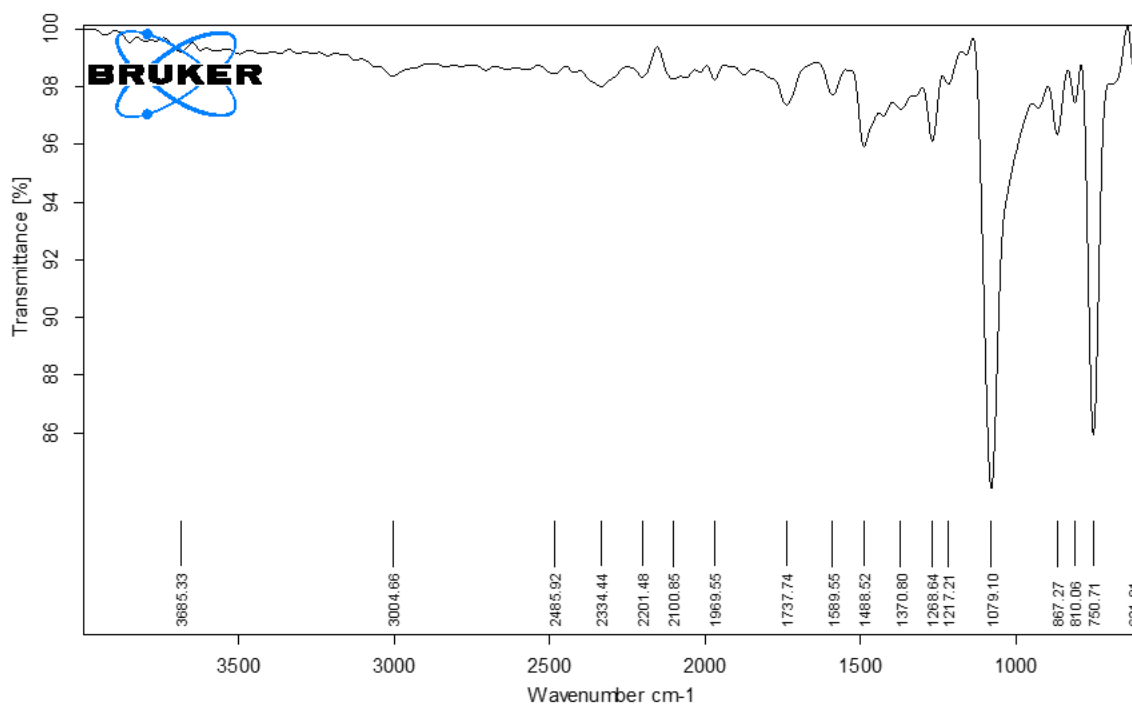


Fig. S2 FT-IR (solid) of L

a)



b)



c)

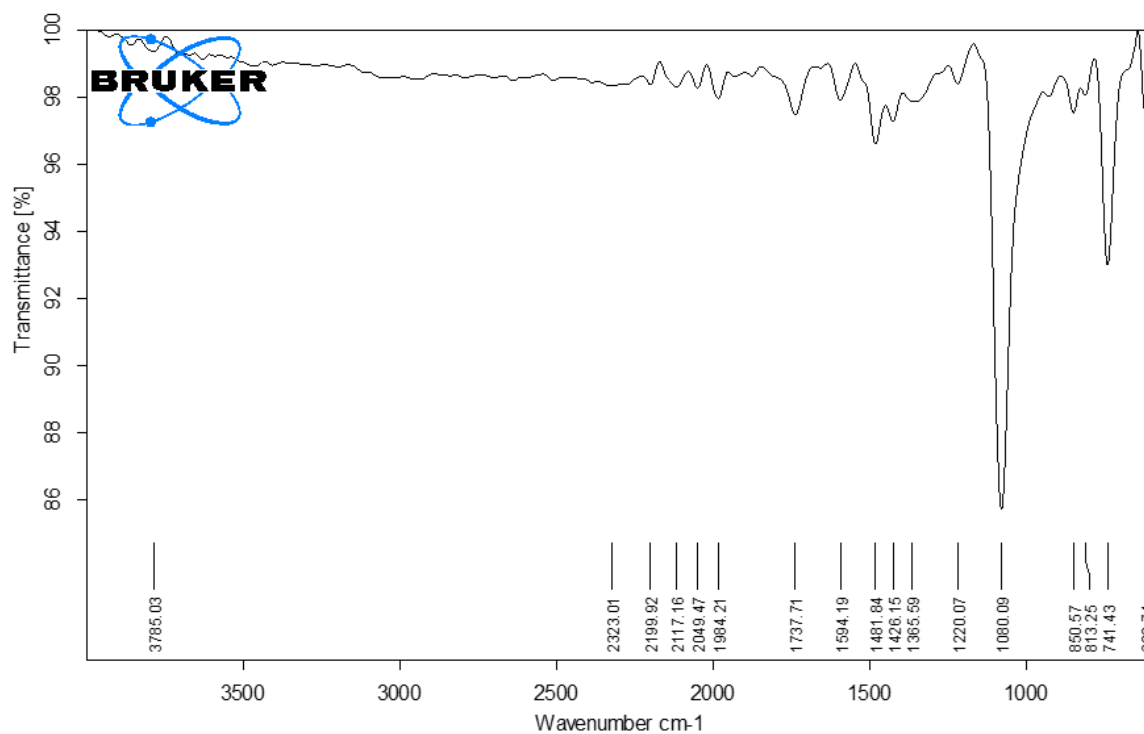
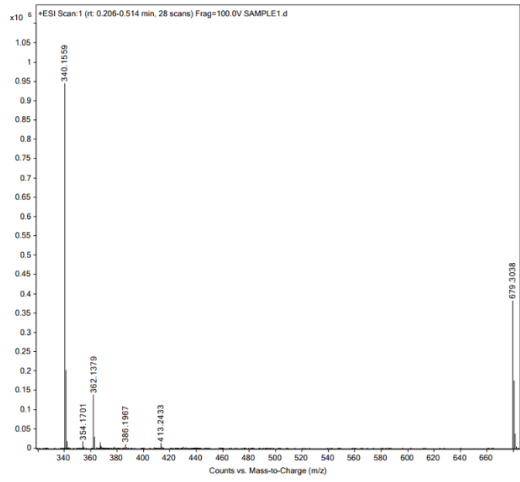
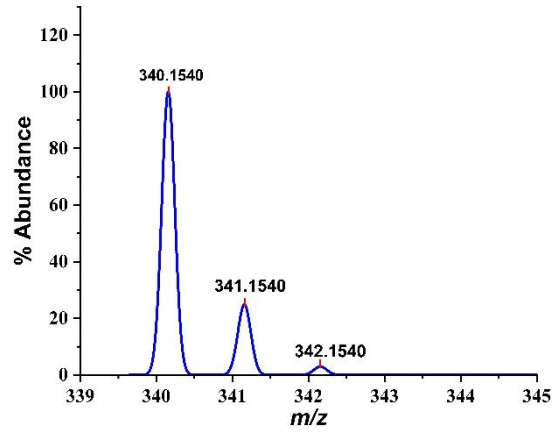


Fig. S3 FT-IR (solid) spectra of a) 1, b) 2, and c) 3.

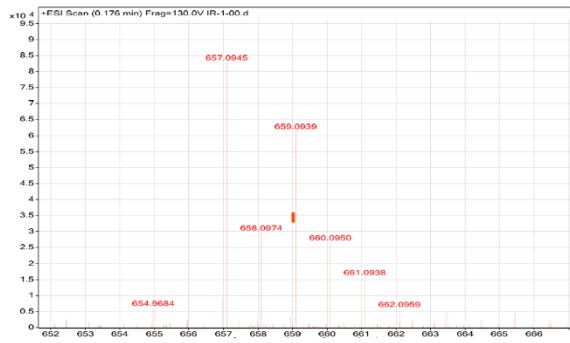
a)



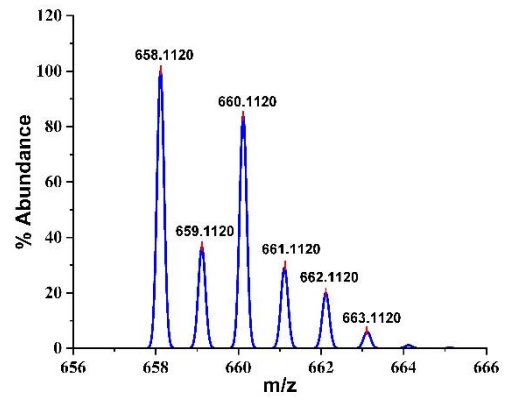
b)



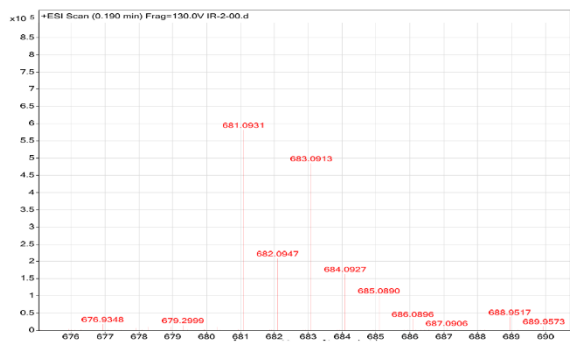
c)



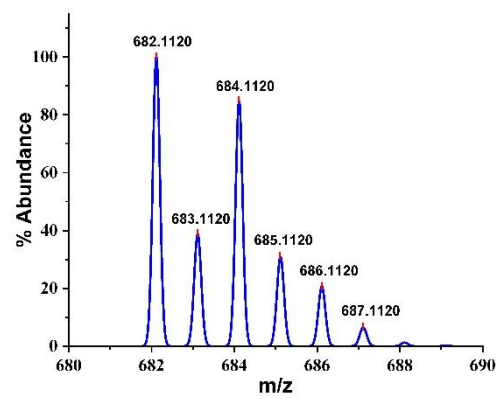
d)



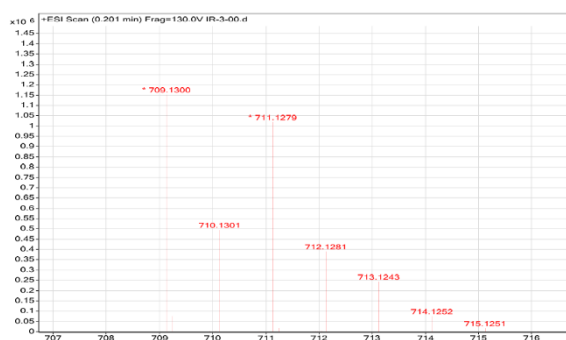
e)



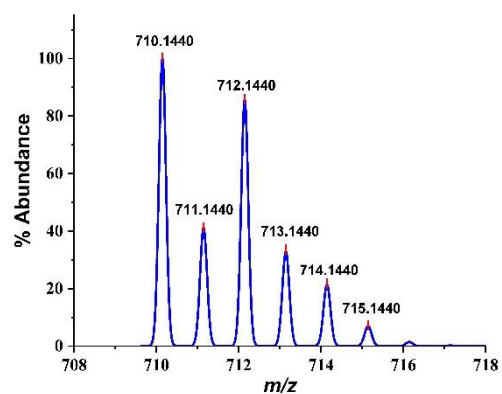
f)



g)

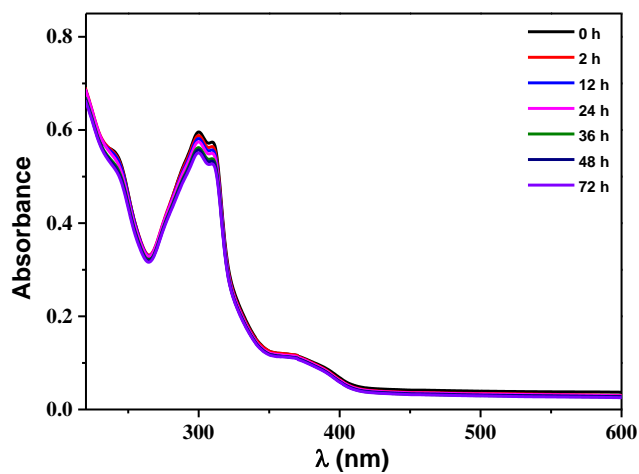


h)

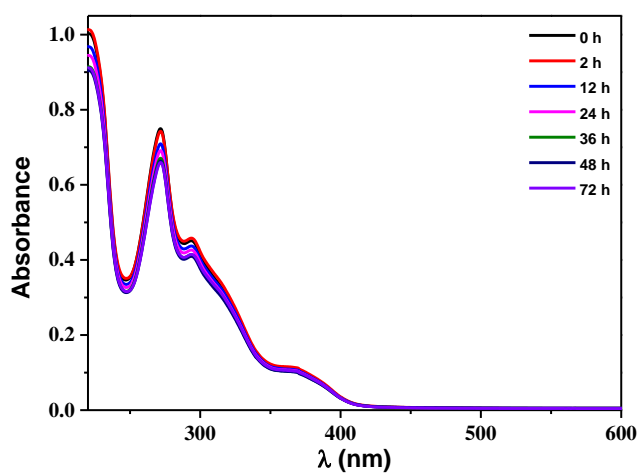


**Fig. S4** HRMS spectra of the **L** a) experimental, b) simulated, **1** c) experimental, d) simulated, **2** e) experimental, f) simulated, and **3** g) experimental, h) simulated.

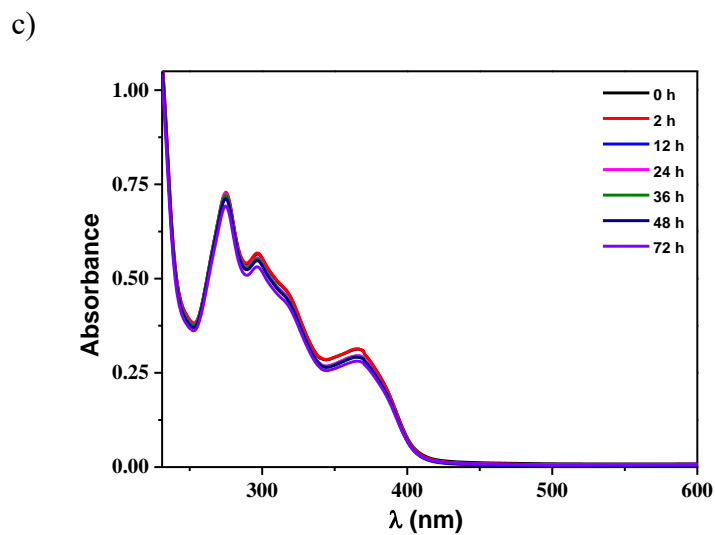
a)



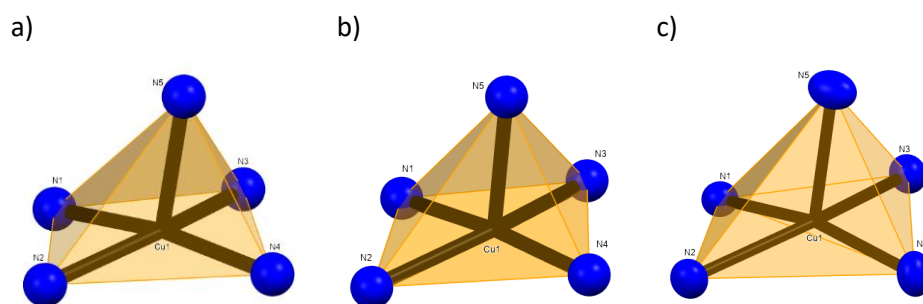
b)



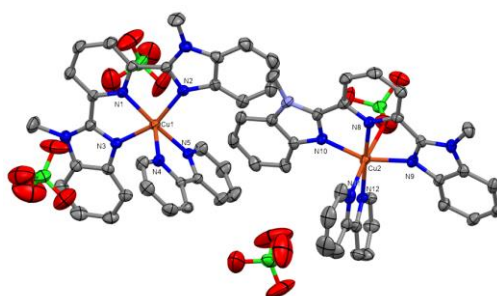




**Fig. S5** Stability of (a) **1**, b) **2**, and (c) **3** in Tris-HCl buffer solution (pH 7.4) for three days.

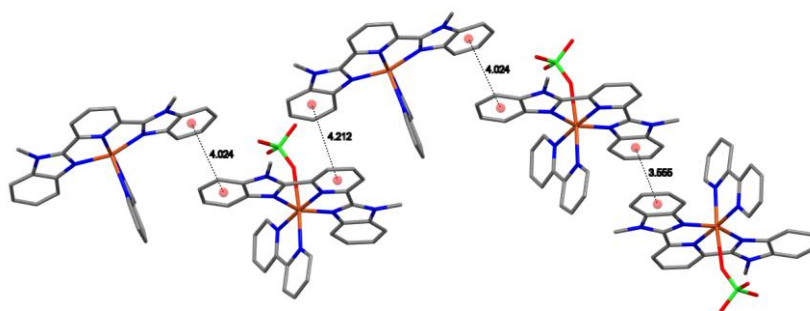


**Fig. S6** Polyhedral view of a) **1**, b) **2** and c) **3**.

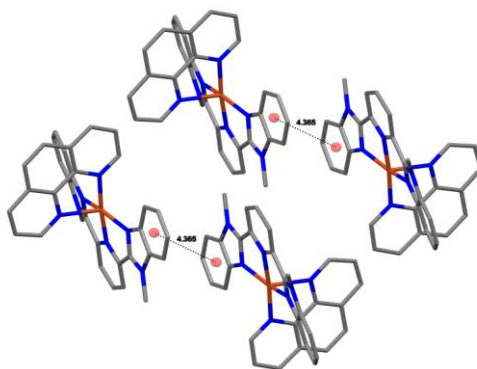


**Fig. S7** The two non-equivalent Cu(II) units present in the crystal symmetry of **1**.

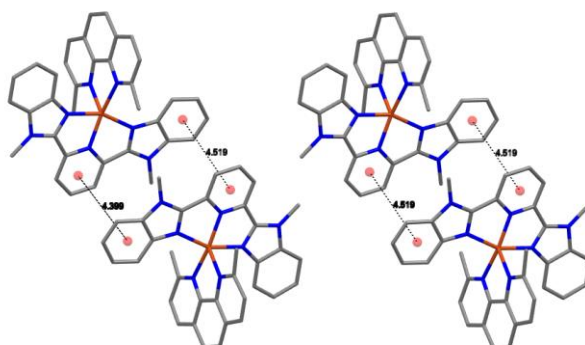
a)



b)

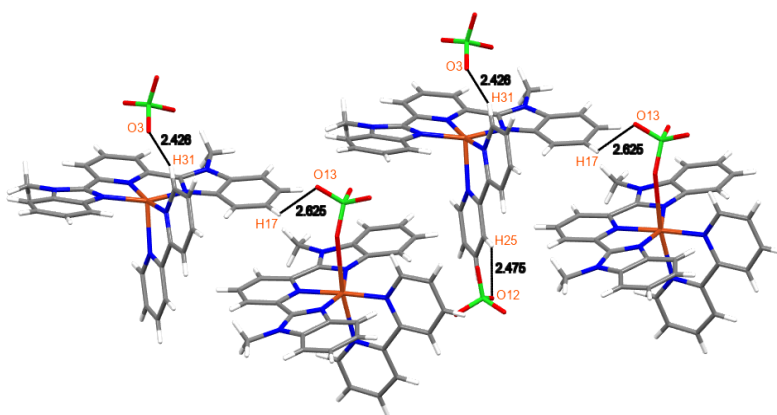


c)

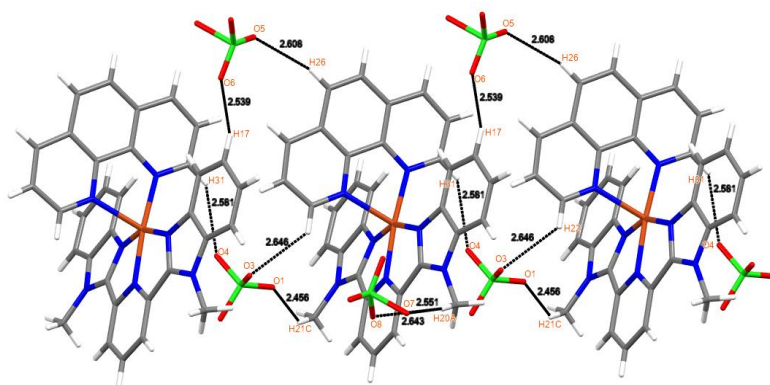


**Fig. S8** Displaced  $\pi$ - $\pi$  stacking interaction present in the crystal structures of a) **1**, b) **2** and c) **3**.

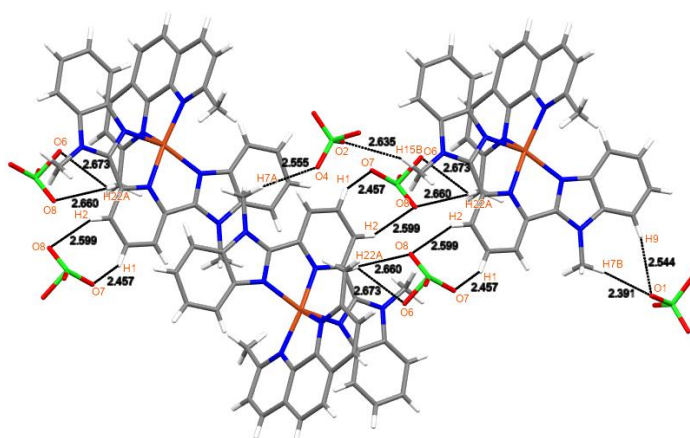
a)



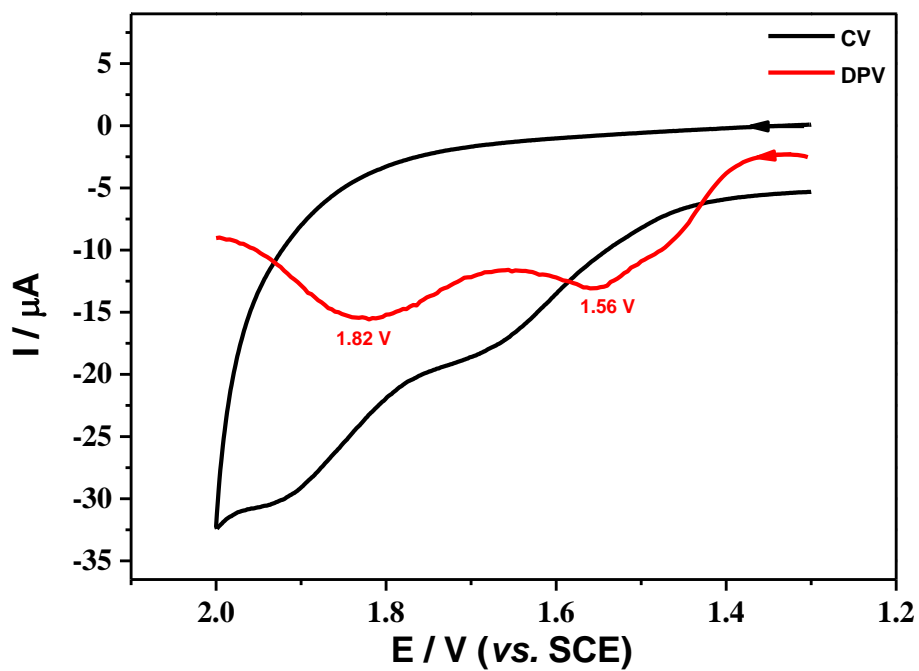
b)



c)

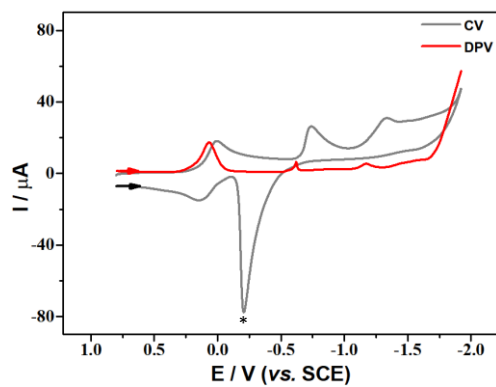


**Fig. S9** Intermolecular H-bonding interactions present in the crystal symmetry of a) 1, b) 2 and c) 3.

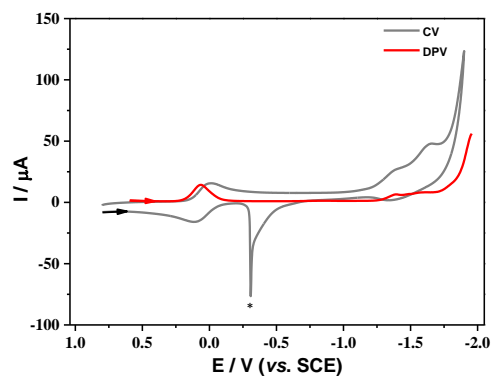


**Fig. S10** CV (black line) and DPV (red line) of ligand **L** in dry acetonitrile solvent using 0.1 M TBAP as supporting electrolyte under nitrogen atmosphere at a scan rate of  $100 \text{ mV s}^{-1}$ .

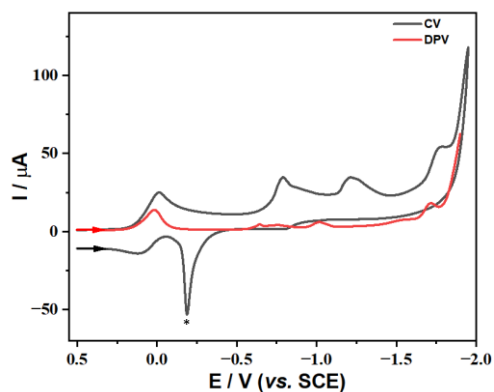
a)



b)



c)



**Fig. S11** CV (black line) and DPV (red line) of a) **1**, b) **2**, and b) **3** in dry acetonitrile solvent using 0.1 M TBAP as supporting electrolyte under nitrogen atmosphere. The \* peak indicates the copper deposition on the electrode surface, for  $\text{Cu}^0 \rightarrow \text{Cu}^{\text{I}}$  oxidation.